

## Description

The AP2204 series is a positive voltage regulator IC fabricated by high voltage EPNP process.

The AP2204 has features of wide input voltage range, high accuracy, high ripple rejection, low dropout voltage, low noise, current limit and ultra-low quiescent current which make it ideal for use in various USB and portable devices.

The IC consists of a voltage reference, an error amplifier, a resistor network for setting output voltage, a current limit circuit for current protection, and a chip enable circuit.

The AP2204 has 1.5V, 1.8V, 2.5V, 2.8V, 3.0V, 3.3V, 5.0V fixed voltage versions and adjustable voltage version.

The AP2204 is available in space-saving SOT-23-5, SOT-89 and PSOP-8 packages.

## Features

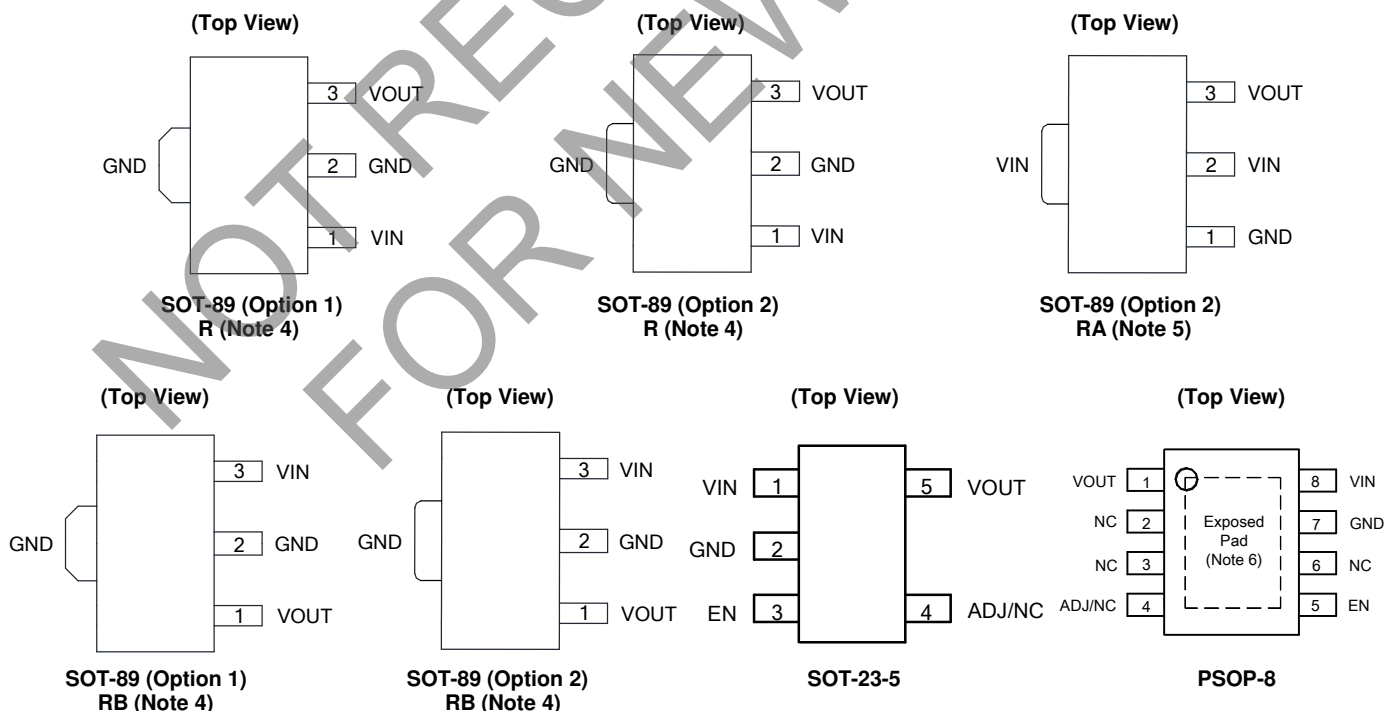
- Wide Input Voltage Range: 2.6V to 24V
- Wide Output Voltage Range: 1.24V to 22V
- Excellent Ripple Rejection: 60dB@ f = 1kHz
- Low Dropout Voltage:  $V_{DROF} = 100mV@ I_{OUT} = 100\mu A$
- Low Ground Current
- High Output Voltage Accuracy
- Compatible with Low ESR Ceramic Capacitor
- Excellent Line/Load Regulation
- Thermal Shutdown Function
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](#) or your local Diodes representative. <https://www.diodes.com/quality/product-definitions/>**

## Applications

- Battery-powered Equipment
- Laptop, Palmtops, Notebook Computers
- Portable Information Appliances

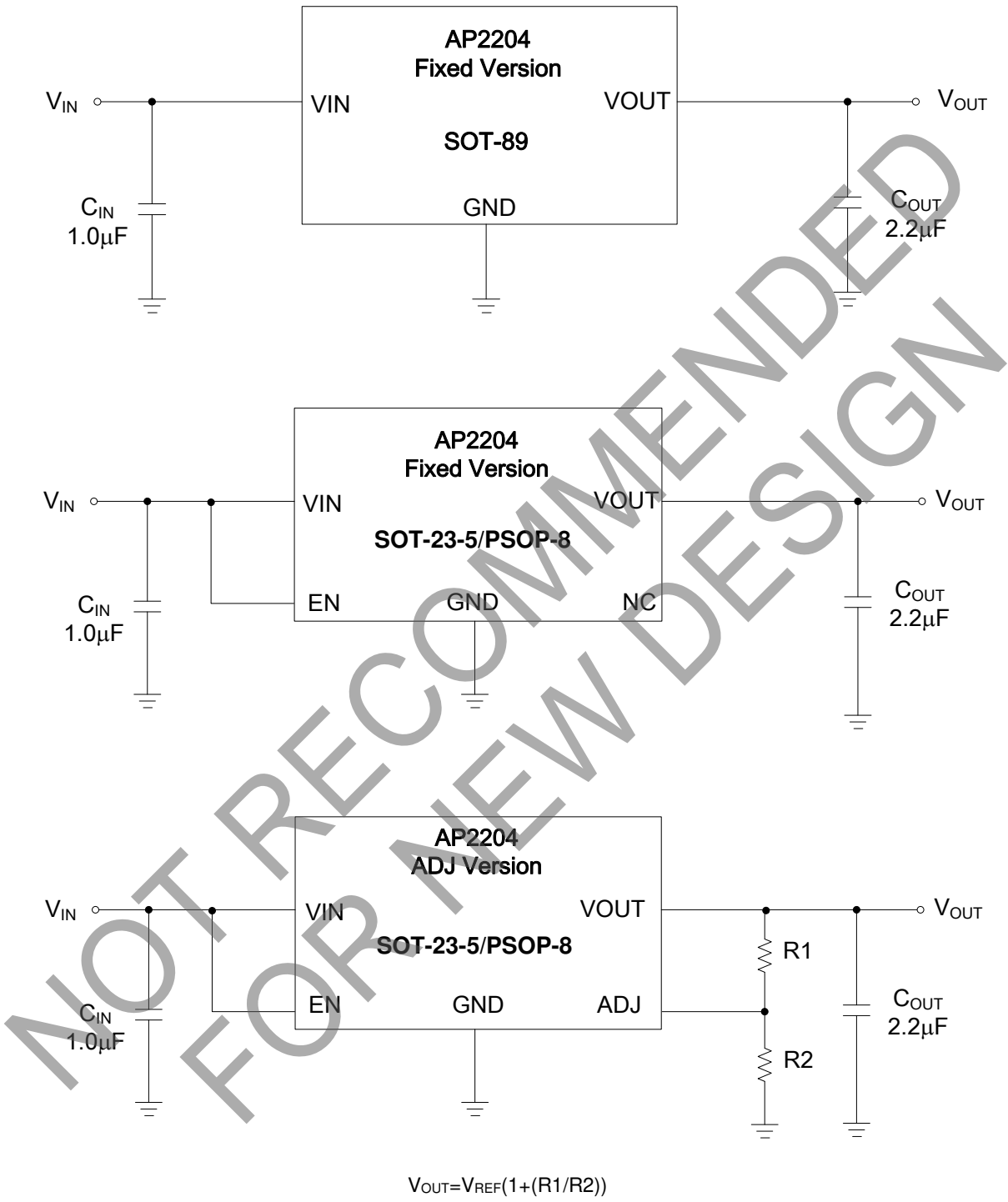
- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
  2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

## Pin Assignments



- Notes:
4. The substrate/exposed pad should be connected to GND.
  5. The substrate/exposed pad should be connected to VIN.
  6. The exposed pad should be connected to GND for better dissipation.

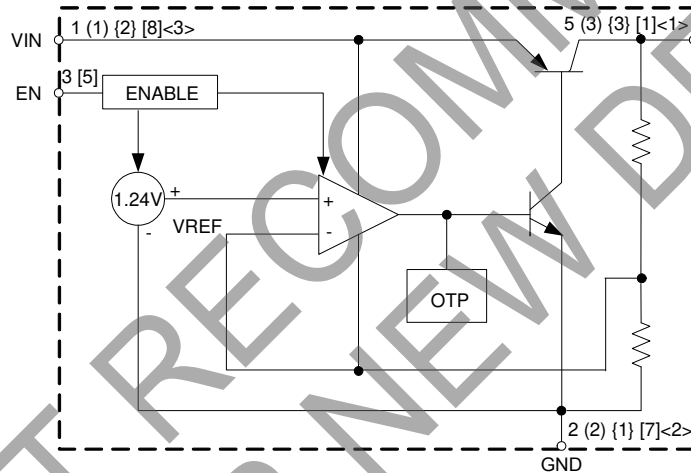
**Typical Applications Circuit**



**Pin Descriptions**

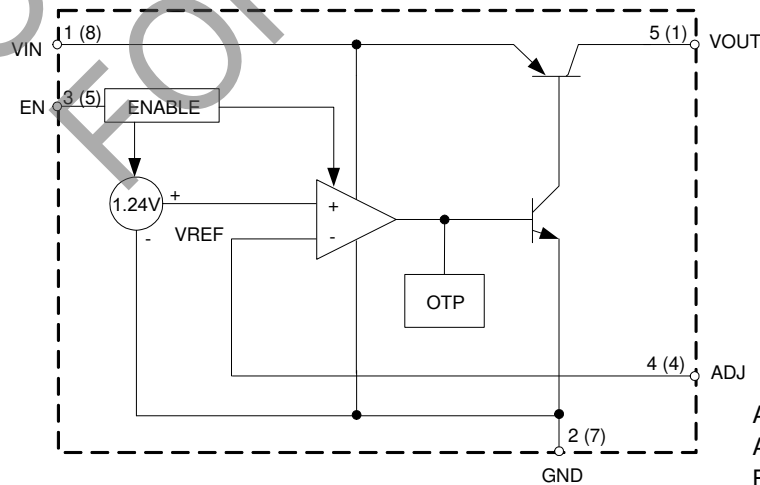
Pin Number					Pin Name	Function
SOT-23-5	PSOP-8	SOT-89				
		R	RA	RB		
1	8	1	2	3	VIN	Input voltage
2	7	2	1	2	GND	Ground
3	5	—	—	—	EN	Enable input
4	4	—	—	—	ADJ/NC	ADJ- Adjust output for ADJ version NC- Not connected for fixed version, Not Connected internally. Recommend connection to GND to maximize PCB copper for thermal dissipation.
5	1	3	3	1	VOUT	Regulated output voltage

**Functional Block Diagram**



Fixed Output Voltage

A (B) {C} [D] <E>  
 A for SOT-23-5  
 B for SOT-89 (R)  
 C for SOT-89 (RA)  
 D for PSOP-8  
 E for SOT-89 (RB)



Adjustable Output Voltage

A (B)  
 A for SOT-23-5  
 B for PSOP-8

### Absolute Maximum Ratings (Note 7)

Symbol	Parameter	Rating		Unit
V <sub>IN</sub>	Supply Input Voltage	38		V
V <sub>CE</sub>	Enable Input Voltage	38		V
I <sub>OUT</sub>	Output Current	250		mA
T <sub>LEAD</sub>	Lead Temperature (Soldering, 10sec)	+260		°C
T <sub>J</sub>	Operating Junction Temperature	+150		°C
θ <sub>JA</sub>	Thermal Resistance	SOT-23-5	250	°C/W
		SOT-89	165	
		PSOP-8 (Note 8)	51	
T <sub>STG</sub>	Storage Temperature Range	-65 to +150		°C
—	ESD (Machine Model)	275		V
—	ESD (Human Body Model)	2000		V

- Notes:
- Stresses greater than those listed under "Absolute Maximum Ratings" can cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods can affect device reliability.
  - θ<sub>JA</sub> is measured with the component mounted on a 2-Layer FR-4 PCB board with 1.5cm\*1.5cm thermal sink pad in free air.

### Recommended Operating Conditions

Symbol	Parameter	Min	Max	Unit
V <sub>IN</sub>	Supply Input Voltage	2.6 (Note 9)	24	V
T <sub>J</sub>	Operating Junction Temperature	-40	+125	°C

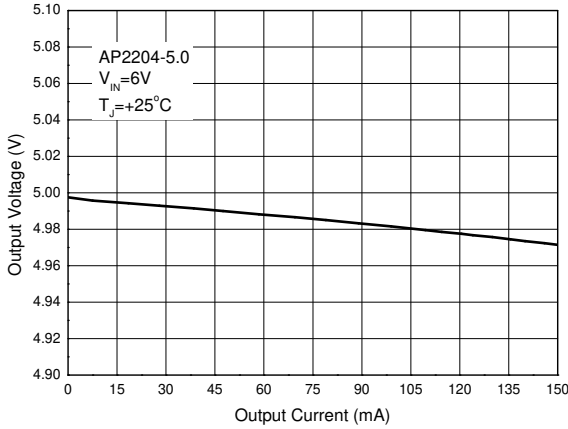
- Note:
- Minimum recommended input voltage is the larger of 2.6V or V<sub>OUT</sub> + 1V. Below this value the device may enter drop-out conditions and cease to regulate the output voltage correctly.

**Electrical Characteristics** (@ $V_{IN} = V_{OUT} + 1V$ ,  $T_J = +25^\circ C$ ,  $I_{OUT} = 100\mu A$ ,  $C_{IN} = 1.0\mu F$ ,  $C_{OUT} = 2.2\mu F$ , **Bold** typeface applies over  $-40^\circ C \leq T_J \leq +125^\circ C$ , unless otherwise specified.)

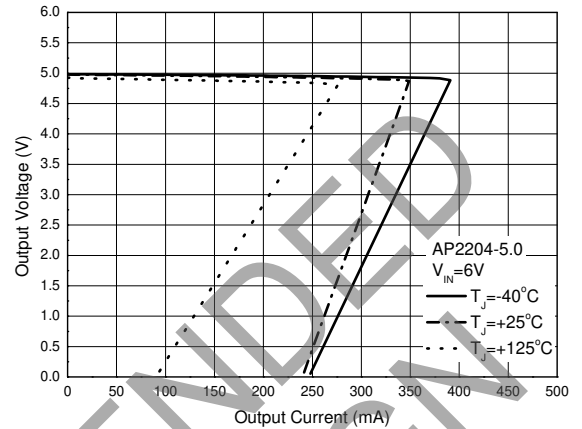
Symbol	Parameter	Conditions	Min	Typ	Max	Unit	
$V_{OUT}$	Output Voltage	Variation from Specified $V_{OUT}$	$V_{OUT} \times 98\%$	—	$V_{OUT} \times 102\%$	V	
$V_{REF}$	Reference Voltage	—	1.215	1.24	1.265	V	
$V_{IN}$	Input Voltage	—	—	—	24	V	
$I_{OUT(max)}$	Maximum Output Current	$V_{IN} - V_{OUT} = 1V$ , $V_{OUT} = 98\% \times V_{OUT}$	150	200	—	mA	
$\Delta V_{OUT}/\Delta V_{IN}$	Line Regulation	$V_{OUT} + 1V \leq V_{IN} \leq 24V$	—	0.05	—	%	
$\Delta V_{OUT}/V_{OUT}$	Load Regulation	$1mA \leq I_{OUT} \leq 150mA$	—	0.5	—	%	
$V_{DROP}$	Dropout Voltage	$I_{OUT} = 100\mu A$	—	100	150	mV	
		$I_{OUT} = 50mA$	—	270	350		
		$I_{OUT} = 100mA$	—	320	460		
		$I_{OUT} = 150mA$	—	360	500		
$I_{GND}$	Ground Current	$I_{OUT} = 0A$	—	20	—	$\mu A$	
		$I_{OUT} = 100\mu A$	—	50	—		
		$I_{OUT} = 50mA$	—	0.5	—	mA	
		$I_{OUT} = 100mA$	—	1.3	—		
		$I_{OUT} = 150mA$	—	2.5	—		
$I_{STD}$	Standby Current	$V_{IN} = V_{OUT} + 1V$ $V_{EN}$ in OFF Mode	—	0.01	1.0	$\mu A$	
$PSRR$	Power Supply Rejection Ratio	Ripple 0.5V <sub>P-P</sub> $V_{IN} = V_{OUT} + 1V$	$f = 100Hz$	—	60	—	dB
			$f = 1kHz$	—	60	—	
$\Delta V_{OUT}/(V_{OUT} \times \Delta T)$	Output Voltage Temperature Coefficient	$I_{OUT} = 100\mu A$ , $-40^\circ C \leq T_J \leq +125^\circ C$	—	<b><math>\pm 100</math></b>	—	ppm/ $^\circ C$	
$V_{NOI}$	RMS Output Noise	$T_J = +25^\circ C$ , $10Hz \leq f \leq 100kHz$	—	30	—	$\mu V_{rms}$	
$I_{ADJ}$	ADJ Pin Current	$I_{OUT} = 100\mu A$	—	0.5	—	$\mu A$	
$I_{EN}$	EN Pin Current	$V_{EN} = V_{OUT} + 1V$	—	1	—	$\mu A$	
—	EN "High" Voltage	EN Input Voltage "High"	2.0	—	—	V	
—	EN "Low" Voltage	EN Input Voltage "Low"	—	—	0.4	V	
$\theta_{JC}$	Thermal Resistance (Junction to Case)	SOT-23-5	—	43	—	$^\circ C/W$	
		SOT-89	—	27	—		
		PSOP-8	—	22	—		

**Performance Characteristics**

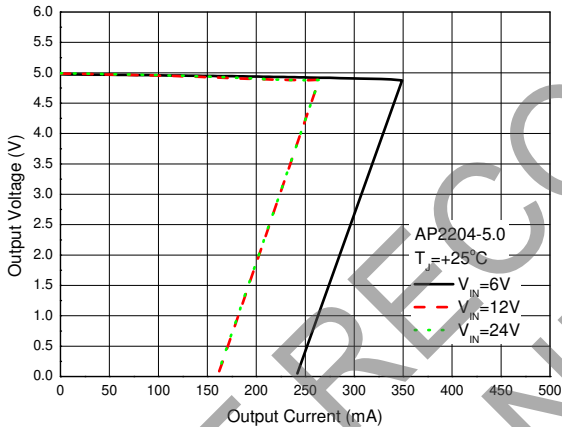
**Output Voltage vs. Output Current**



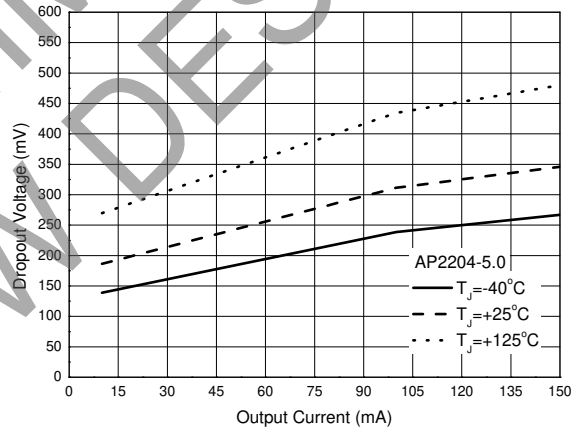
**Output Voltage vs. Output Current**



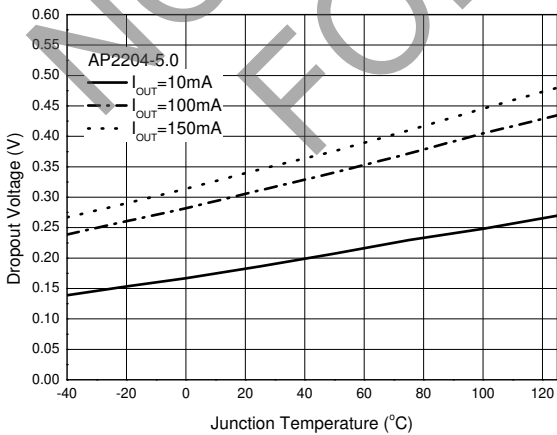
**Output Voltage vs. Output Current**



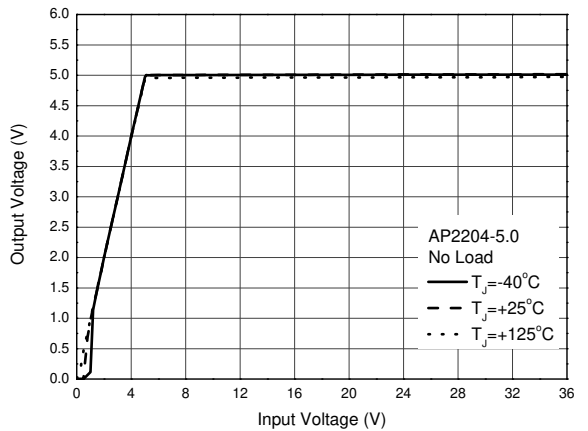
**Dropout Voltage vs. Output Current**



**Dropout Voltage vs. Junction Temperature**

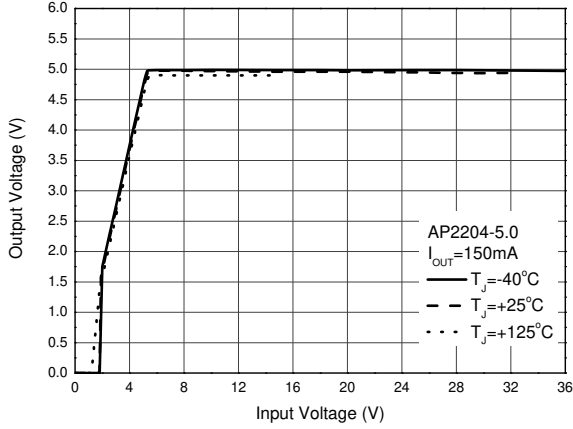


**Output Voltage vs. Input Voltage**

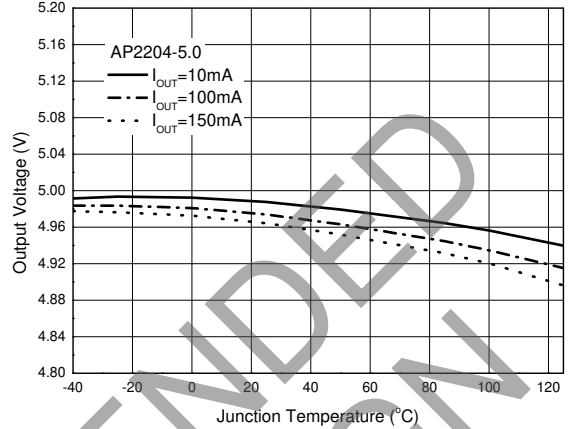


**Performance Characteristics** (continued)

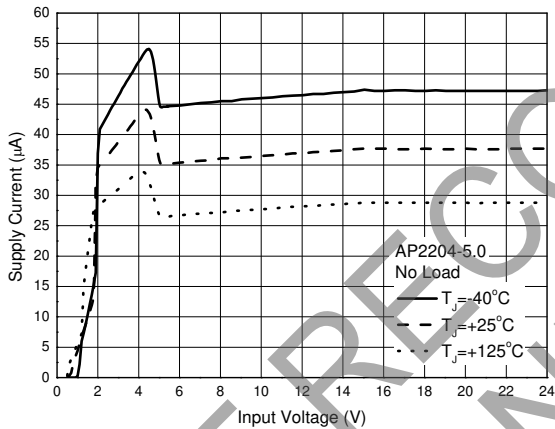
**Output Voltage vs. Input Voltage**



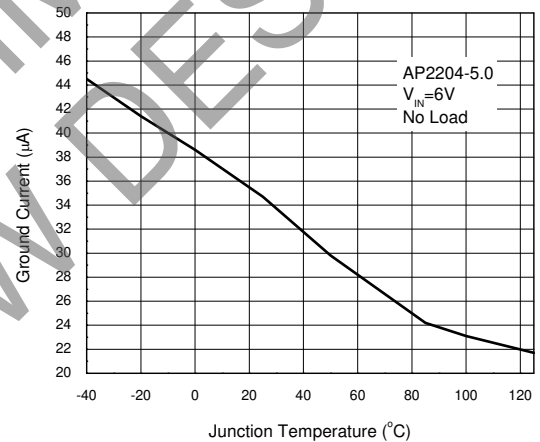
**Output Voltage vs. Junction Temperature**



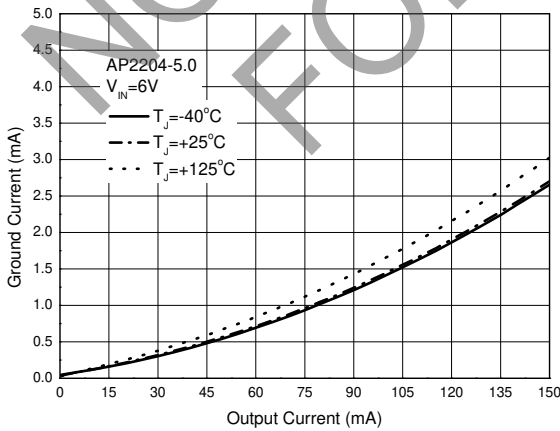
**Supply Current vs. Input Voltage**



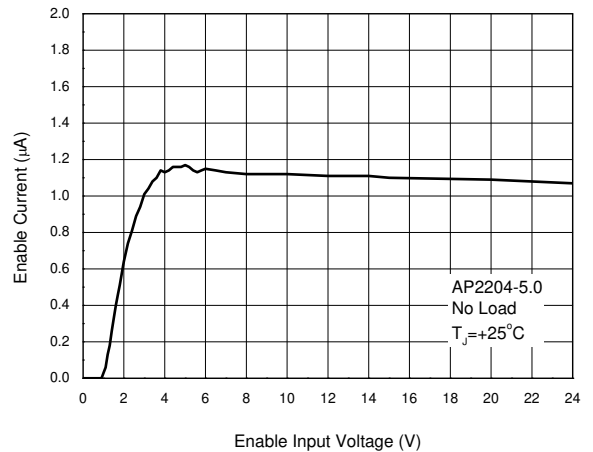
**Ground Current vs. Junction Temperature**



**Ground Current vs. Output Current**

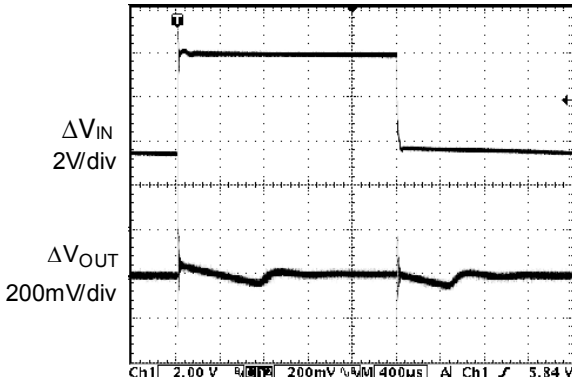


**Enable Current vs. Enable Input Voltage**

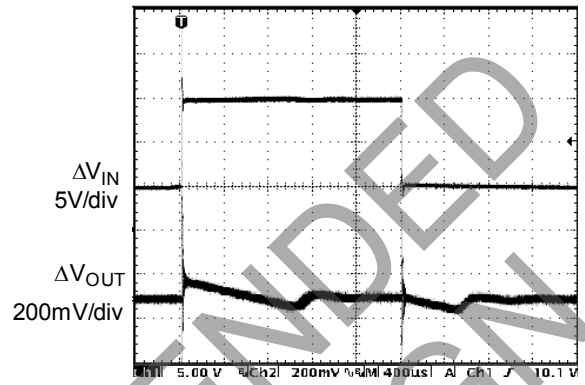


**Performance Characteristics** (continued)

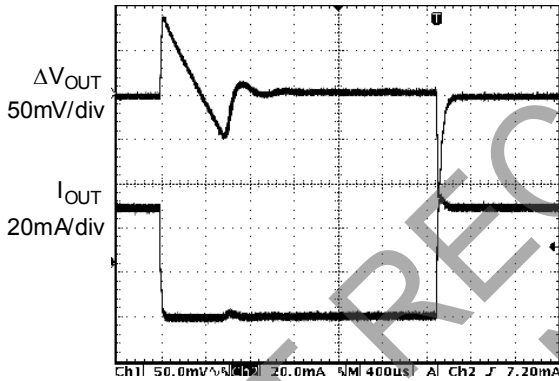
**Line Transient**  
(Conditions:  $V_{IN}=V_{EN}=3.5V$  to  $8V$ ,  $C_{IN}=1.0\mu F$ ,  
 $C_{OUT}=2.2\mu F$ ,  $I_{OUT}=1mA$ )



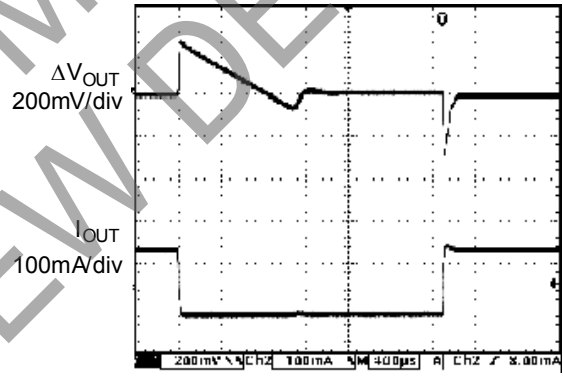
**Line Transient**  
(Conditions:  $V_{IN}=V_{EN}=5V$  to  $15V$ ,  $C_{IN}=1.0\mu F$ ,  
 $C_{OUT}=2.2\mu F$ ,  $I_{OUT}=1mA$ )



**Load Transient**  
(Conditions:  $V_{IN}=5V$ ,  $C_{IN}=1.0\mu F$ ,  $C_{OUT}=2.2\mu F$ ,  
 $I_{OUT}=1mA$  to  $50mA$ )



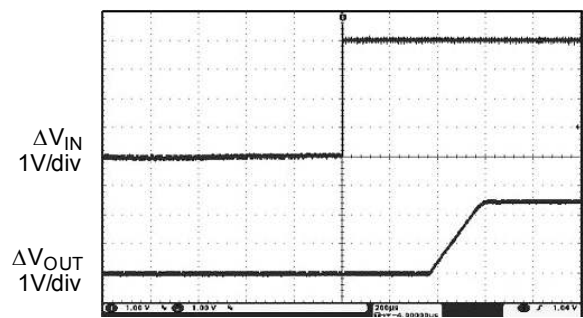
**Load Transient**  
(Conditions:  $V_{IN}=5V$ ,  $C_{IN}=1.0\mu F$ ,  $C_{OUT}=2.2\mu F$ ,  
 $I_{OUT}=1mA$  to  $150mA$ )



**Enable Input Response**



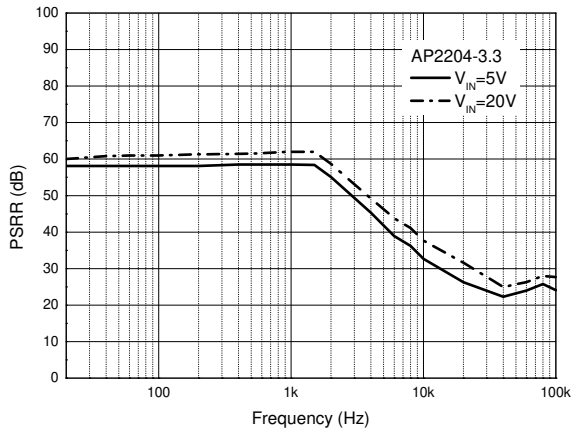
**Start-up Response**



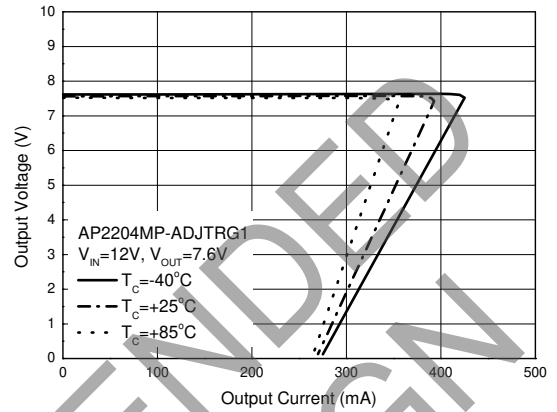


**Performance Characteristics** (continued)

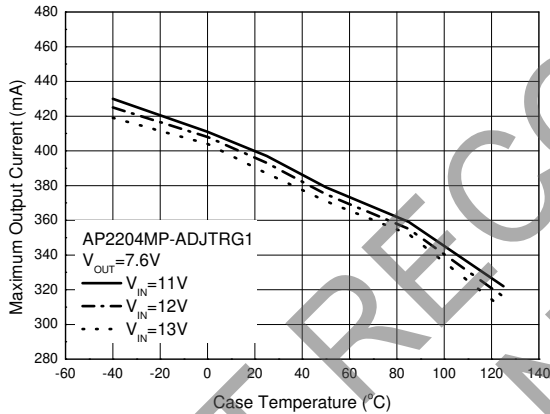
**PSRR vs. Frequency**  
(Conditions:  $V_{PP}=2V$ ,  $I_{OUT}=10mA$ )



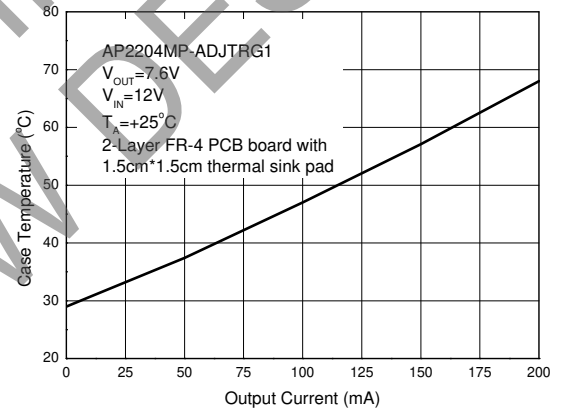
**Output Voltage vs. Output Current**

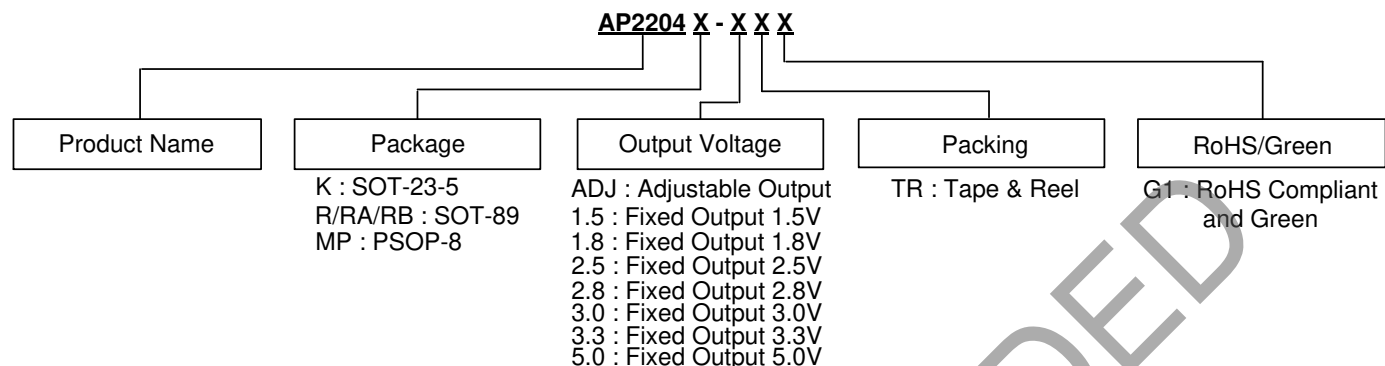


**Maximum Output Current vs. Case Temperature**



**Case Temperature vs. Output Current**



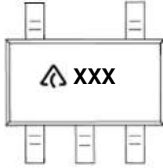
**Ordering Information**



Package	Temperature Range	Output Voltage	Part Number	Marking ID	Packing
SOT-23-5	-40 to +85°C	ADJ	AP2204K-ADJTRG1	GAF	3000/7" Tape & Reel
		1.5V	AP2204K-1.5TRG1	GBH	3000/7" Tape & Reel
		1.8V	AP2204K-1.8TRG1	GAG	3000/7" Tape & Reel
		2.5V	AP2204K-2.5TRG1	GAD	3000/7" Tape & Reel
		2.8V	AP2204K-2.8TRG1	GAE	3000/7" Tape & Reel
		3.0V	AP2204K-3.0TRG1	GEF	3000/7" Tape & Reel
		3.3V	AP2204K-3.3TRG1	GAH	3000/7" Tape & Reel
		5.0V	AP2204K-5.0TRG1	GAI	3000/7" Tape & Reel
SOT-89	-40 to +85°C	1.5V (R)	AP2204R-1.5TRG1	G22C	1000/7" Tape & Reel
		1.8V (R)	AP2204R-1.8TRG1	G31C	1000/7" Tape & Reel
		2.5V (R)	AP2204R-2.5TRG1	G22D	1000/7" Tape & Reel
		2.8V (R)	AP2204R-2.8TRG1	G22E	1000/7" Tape & Reel
		3.0V (R)	AP2204R-3.0TRG1	G22F	1000/7" Tape & Reel
		3.3V (R)	AP2204R-3.3TRG1	G31D	1000/7" Tape & Reel
		5.0V (R)	AP2204R-5.0TRG1	G31E	1000/7" Tape & Reel
SOT-89	-40 to +85°C	3.3V (RA)	AP2204RA-3.3TRG1	G37O	1000/7" Tape & Reel
		5.0V (RA)	AP2204RA-5.0TRG1	G41O	1000/7" Tape & Reel
SOT-89	-40 to +85°C	3.3V (RB)	AP2204RB-3.3TRG1	G37R	1000/7" Tape & Reel
		5.0V (RB)	AP2204RB-5.0TRG1	G41R	1000/7" Tape & Reel
PSOP-8	-40 to +85°C	ADJ	AP2204MP-ADJTRG1	2204MP-ADJG1	4000/13" Tape & Reel

**Marking Information**

(1) SOT-23-5

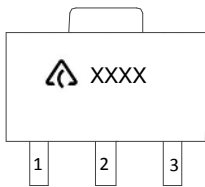
(Top View)



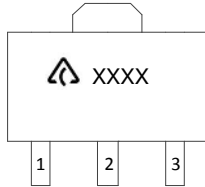
 : Logo  
 XXX: Marking ID (See Ordering Information)

(2) SOT-89

(Top View)



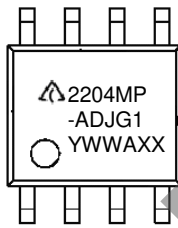
(Top View)



First Line: Logo and Marking ID  
 (See Ordering Information)

(3) PSOP-8

(Top View)



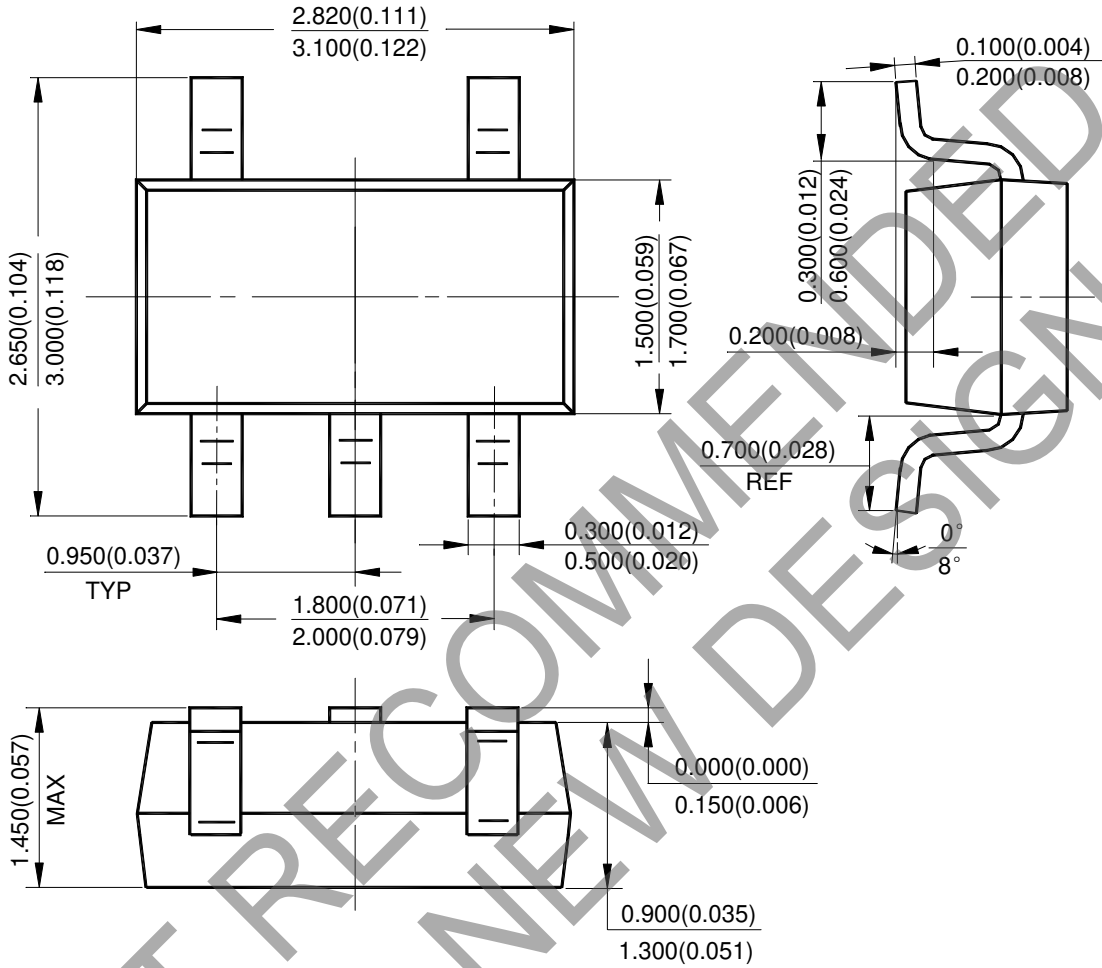
First and Second Lines: Logo and Marking ID  
 (See Ordering Information)  
 Third Line: Date Code  
 Y: Year  
 WW: Work Week of Molding  
 A: Assembly House Code  
 XX: 7<sup>th</sup> and 8<sup>th</sup> Digits of Batch Number

NOT RECOMMENDED FOR NEW DESIGN

**Package Outline Dimensions** (All dimensions in mm(inch).)

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

(1) Package Type: SOT-23-5

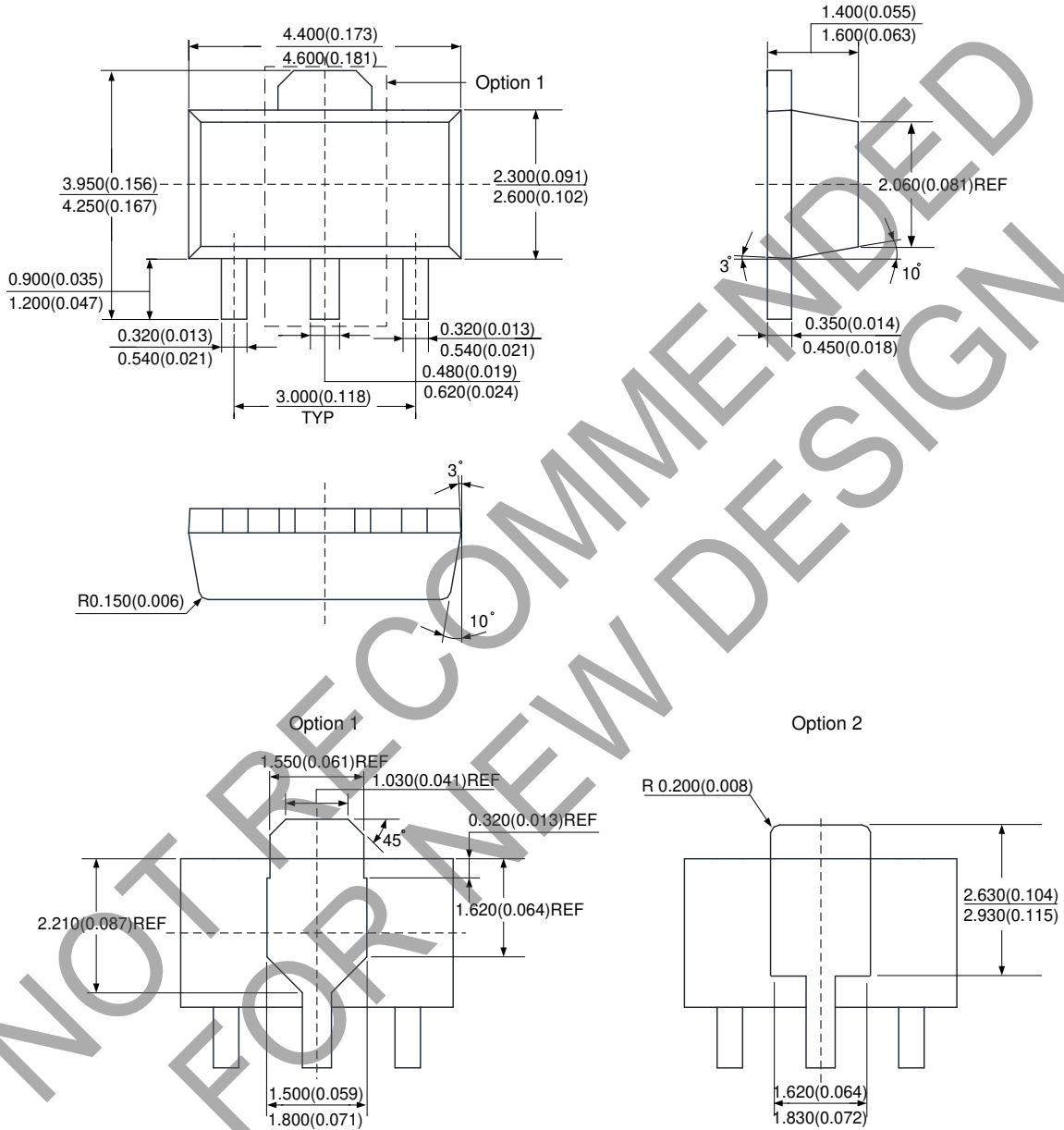


NOT RECOMMENDED FOR NEW DESIGN

**Package Outline Dimensions** (All dimensions in mm(inch).) (continued)

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

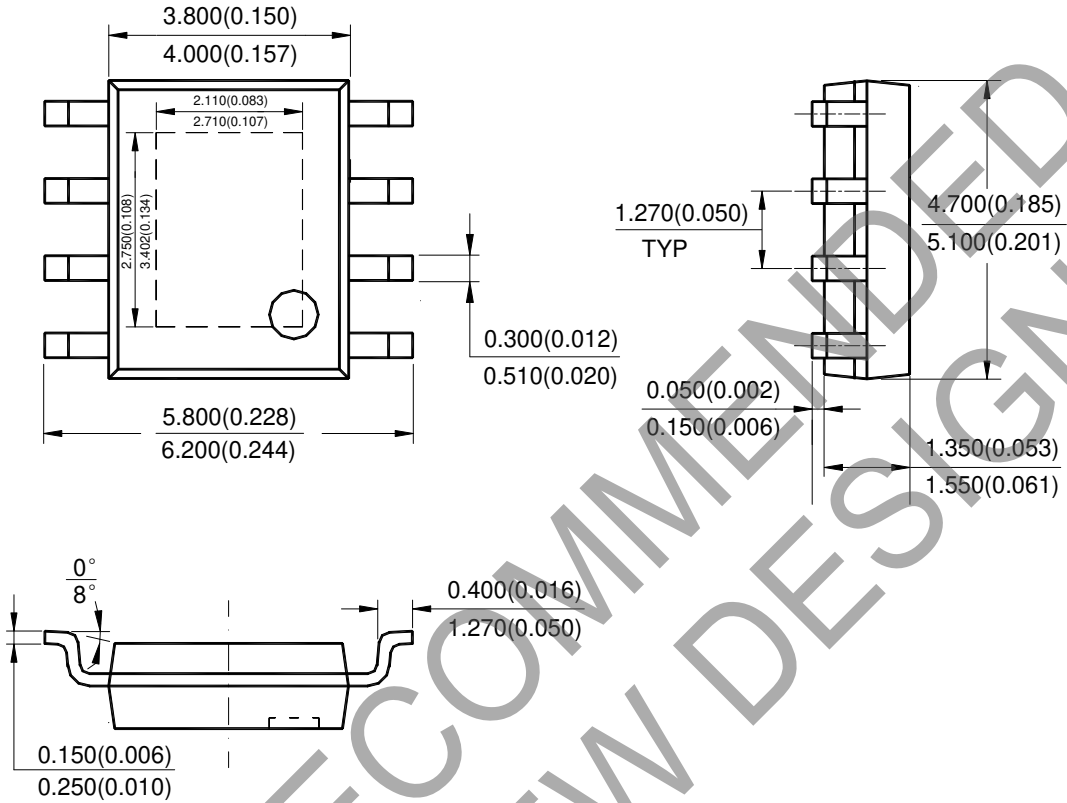
(2) Package Type: SOT-89



**Package Outline Dimensions** (All dimensions in mm(inch).) (continued)

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

(3) Package Type: PSOP-8



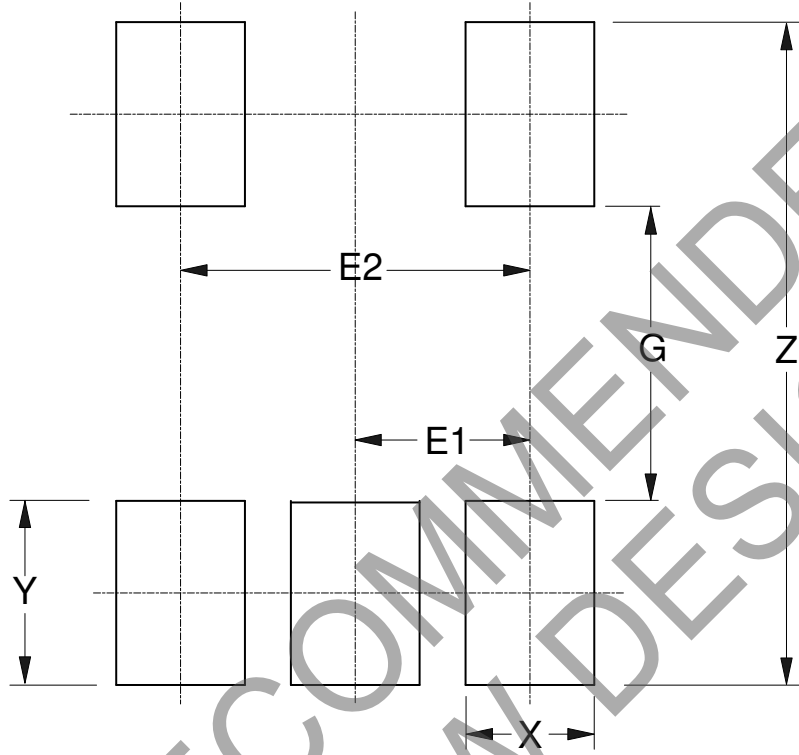
Note: Eject hole, oriented hole and mold mark is optional.

NOT RECOMMENDED FOR NEW DESIGN

**Suggested Pad Layout**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

(1) Package Type: SOT-23-5

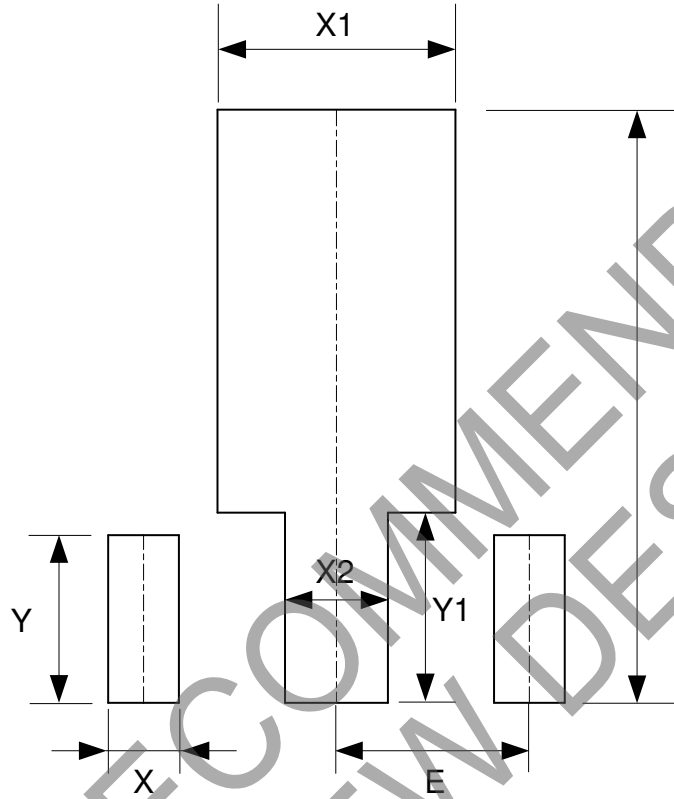


Dimensions	Z (mm)/(inch)	G (mm)/(inch)	X (mm)/(inch)	Y (mm)/(inch)	E1 (mm)/(inch)	E2 (mm)/(inch)
Value	3.600/0.142	1.600/0.063	0.700/0.028	1.000/0.039	0.950/0.037	1.900/0.075

**Suggested Pad Layout** (continued)

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

(2) Package Type: SOT-89



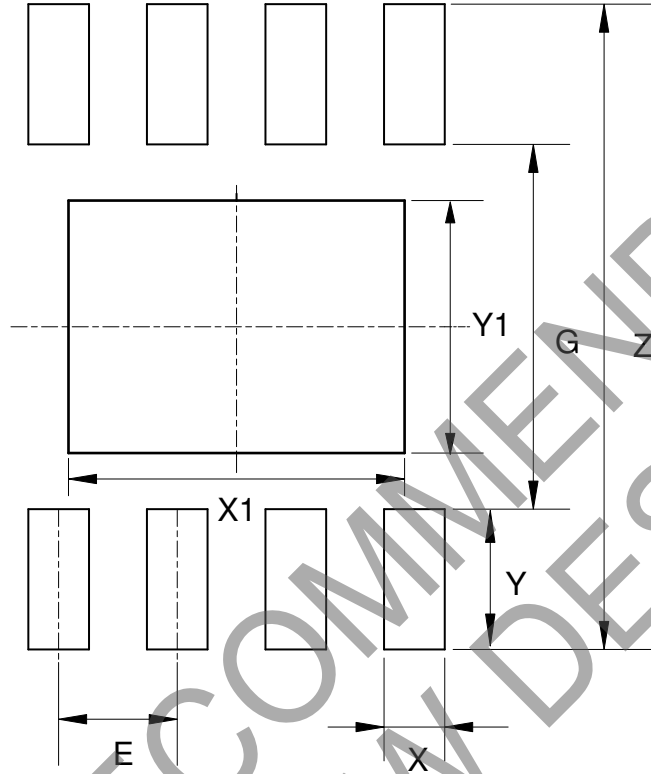
Dimensions	Z (mm)/(inch)	X (mm)/(inch)	X1 (mm)/(inch)	X2 (mm)/(inch)	Y (mm)/(inch)	Y1 (mm)/(inch)	E (mm)/(inch)
Value	4.600/0.181	0.550/0.022	1.850/0.073	0.800/0.031	1.300/0.051	1.475/0.058	1.500/0.059



**Suggested Pad Layout** (continued)

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

(3) Package Type: PSOP-8



Dimensions	Z (mm)/(inch)	G (mm)/(inch)	X (mm)/(inch)	Y (mm)/(inch)	X1 (mm)/(inch)	Y1 (mm)/(inch)	E (mm)/(inch)
Value	6.900/0.272	3.900/0.154	0.650/0.026	1.500/0.059	3.600/0.142	2.700/0.106	1.270/0.050

**IMPORTANT NOTICE**

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

**LIFE SUPPORT**

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

A. Life support devices or systems are devices or systems which:

1. are intended to implant into the body, or
2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.

B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2020, Diodes Incorporated

[www.diodes.com](http://www.diodes.com)